

1. SCOPE

This specification shall cover the characteristics of the ceramic resonator with the type ZTTWS4.19MG.

2. PART NO:

PART NUMBER	CUSTOMER PART NO	SPECIFICATION NO
ZTTWS4.19MG		

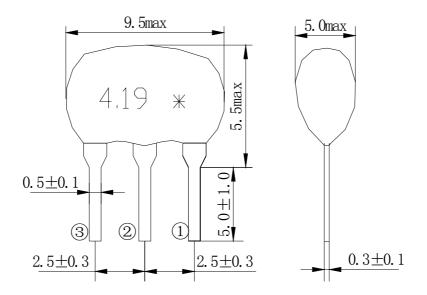
3. OUTLINE DRAWING AND STRUCTURE

3.1 Appearance: No visible damage and dirt.

3.2 Construction: Leads are soldered on electrode and body is molded by resin.

3.3 Except the chip(ceramic element, ceramic base, capacitance slice), the materials don't contain lead.

3.4 Dimensions



Iuput
Ground
Output
EIAJ MONTHLY CODE



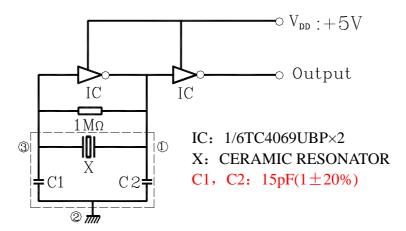
ZTTWS4.19MG

4 RATING AND ELECTRICAL SPECIFICATIONS

4.1 RATING

Items	Content		
Withstanding Voltage (V)	50 (DC, 1min)		
Insulation Resistance Ri, $(M \Omega)$ min.	100 (100V, 1min)		
Operating Temperature Range (°C)	-20~+80		
Storage Temperature Range (°C)	-40~+85		
4.2 ELECTRICAL SPECIFICATIONS			
Items	Content		
Oscillation Frequency Fosc (MHz)	4.190		
Frequency Accuracy (%)	± 0.5		
Resonant Impedance Ro (Ω) max.	30		
Temperature Coefficient of Oscillation Frequency (%) max.	± 0.3 (Oscillation Frequency drift, -25°C~+85°C)		
Rating Voltage UR (V) max.	6V DC 15V p-p		
Aging Rate (%) max.	± 0.3 (For Ten Years)		

- 5 MEASUREMENT
- 5.1 Measurement Conditions: Parts shall be measured under a condition (Temp.: 20±15°C,Humidity : 65±20% R.H.) unless the standard condition(Temp.: 25±3°C,Humidity : 65±5% R.H.) is regulated to measure.
- 5.2Test Circuit





ZTTWS4.19MG

6 PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

No.	Item	Condition of Test	Performance Requirements
6.1	Humidity	Subject the resonator at $+40^{\circ}C \pm 2^{\circ}C$ and 90%-95% R.H. for 500h, resonator shall be measured after being placed in natural conditions for 1h.	It shall fulfill the specifications in Table 1.
6.2	High Temperature Exposure	Subject the resonator to $+85^{\circ}C \pm 5^{\circ}C$ for 500h, resonator shall be measured after being placed in natural conditions for 1hr.	It shall fulfill the specifications in Table 1.
6.3	Low Temperature Exposure	Subject the resonator to $-25^{\circ}C \pm 5^{\circ}C$ for 500h, resonator shall be measured after being placed in natural conditions for 1h.	It shall fulfill the specifications in Table 1.
6.4	Temperature Cycling	Subject the resonator to -25° C for 30 min. followed by a high temperature of $+85^{\circ}$ C for 30 min. Cycling shall be repeated 5 times. Resonator shall be measured after being placed in natural conditions for 1h.	It shall fulfill the specifications in Table 1.
6.5	Vibration	Subject the resonator to vibration for 2h each in x y and z axis with the amplitude of 1.5mm, the frequency shall be varied uniformly between the limits of 10Hz-55Hz and then resonator shall be measured.	It shall fulfill the specifications in Table 1.
6.6	Mechanical Shock	Resonator shall be measured after 3 times' random dropping from the height of 100cm on concrete floor.	No visible damage and it shall fulfill the specifications in Table 1.
6.7	Resistance to Soldering Heat	Lead terminals are immersed up to 2 mm from resonator's body in soldering bath of $260^{\circ}C \pm 5^{\circ}C$ for $5s \pm 1s$ and then resonator shall be measured after being placed in natural conditions for 1h	It shall fulfill the specifications in Table 1.
6.8	Solderability	Lead terminals are immersed up to 2mm from resonator's body in soldering bath of $250^{\circ}C \pm 5^{\circ}C$ for $2s \pm 0.5s$.	More than 95% of the terminal surface of the resonator shall be covered with fresh solder.



6 PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

6.9	Terminal		
	Strength		
6.9.1	Terminal	Force of 5N is applied to each lead in axial	No visible
	Pulling	direction for $10s \pm 1s$.	damage and it
6.9.2	Terminal	When force of 5N is applied to each lead in	shall fulfill the
	Bending	axial direction, the lead shall folded up 90°	specifications in
		from the axial direction and folded back to	Table 1.
		the axial direction. The speed of folding shall	
		be each 3s.	

Item	Specification after test	
Oscillation Frequency Change Δ fosc/fosc (%) max	± 0.3 (Refer to the initial value)	
Resonant Impedance Ro (Ω) max	30	



ZTTWS4.19MG

7 PACKAGE

To protect the products in storage and transportation, it is necessary to pack them(outer and inner package).On paper pack, the following requirements are requested.

7.1 Section of package

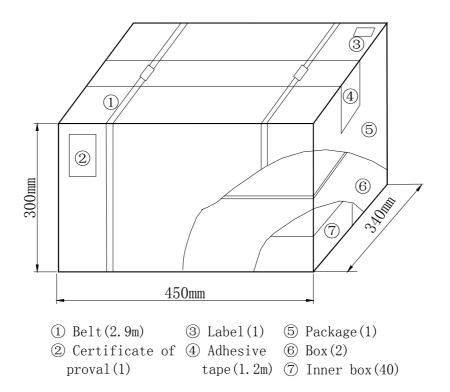
Package is made of corrugated paper with thickness of 0.8cm.Package has 2 inner packages, each has 20 inner boxes (each box for plastic bag).

7.2 Quantity of package

Per plastic bag500 piecesPer inner box3 plastic bagsPer inner package20 inner boxesPer package2 inner packages(60000 pieces of piezoelectric ceramic part)

7.3 Dimensions and Mark

At the end of package, the warning (moisture proof, upward put) should be stick to it(see below)

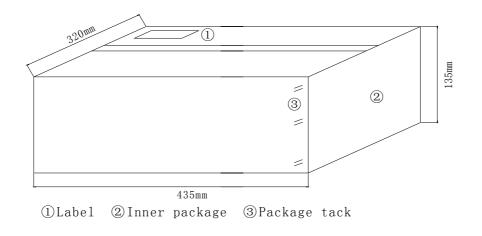


http://www.luguang.cn

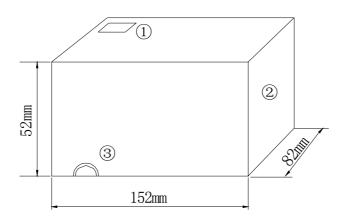




7.4 Inner package



7.5 Inner box Dimensions



Pars shall be packaged in box with hold down tape upside. Part No., quantity and lot No.



8 EIAJ Monthly Code

2003 / 2005 / 2007 / 2009		2004 / 2006 / 2008 / 2010	
MONTH	CODE	MONTH	CODE
JAN	А	JAN	N
FEB	В	FEB	Р
MAR	С	MAR	Q
APR	D	APR	R
MAY	E	MAY	S
JUN	F	JUN	Т
JUL	G	JUL	U
AUG	Н	AUG	V
SEP	J	SEP	W
OCT	K	OCT	Х
NOV	L	NOV	Y
DEC	М	DEC	Z

9 OTHER

9.1 Caution of use

9.1.1 Do not clean or wash the component for it is not hermetically sealed.

9.1.2 Don't be close to fire

9.1.3 Don't apply excess mechanical stress to the component.

9.1.4 Don't bend terminals of the component

9.1.5 This specification mentions the quality of the component as a single unit. Please insure the component is thoroughly evaluated in your application circuit.

9.2 Notice

9.2.1 Please return one of this specification after your signature of acceptance.

9.2.2 When something gets doubtful with this specifications, we shall jointly work to get an agreement.